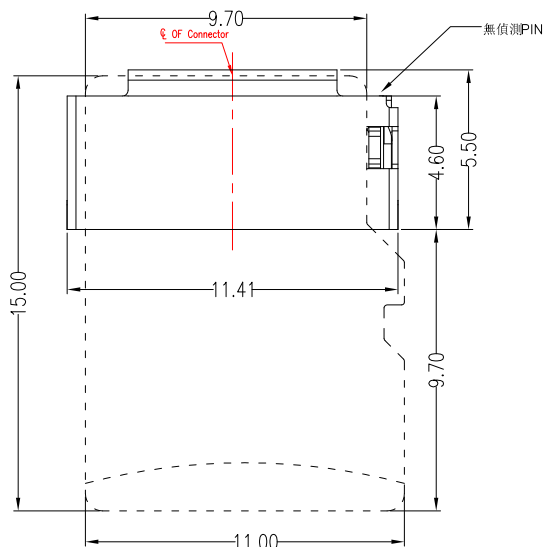
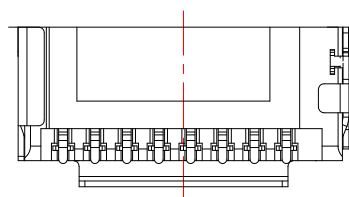


Pin No.	NAME
1	DAT2
2	CD/DAT3
3	CMD
4	VDD
5	CLK
6	VSS
7	DAT0
8	DAT1



- 1.Contact Resistance: 50 mΩ Max.
- 2.Insulation Resistance: 1000 MΩ Min.
- 3.Dielectric Withstanding Voltage: 500V RMS.
- 4.Life Cycles: 1500 cycles Min
- 5.Mate Force: 4.5kgf Max
- 6.Unmate Force: 0.5kgf Min

- 1.Housing: LCP,Black
- 2.Contact: Copper Alloy
- 3.Shell: SPCC

1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall

2.Shell: Nickel under Plated surface layer

1.Operating Temperature: -25°C ~ +85°C.

TOLERANCE UNLESS OTHERWISE STATED :	Up to 5	± 0.2
	Above 5 ~ 15	± 0.3
	Above 15 ~ 30	± 0.4
	Above 30 ~ 50	± 0.5
	Angle	± 0.3°



UNITS

MM

DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR	
Jack Lu	07/13/20					
CHECKED BY:	DATE	FINISH		MODLE	MICRO SD 卡 短體不帶偵測PIN	
Jacky Chen	07/13/20	SCALE	1 : 1	DWG NO.	SD-TF03-1108A2-S304	SIZE A4
APPROVED BY:	DATE	SHEET NO.	1 of 1	PART NO.	SD-TF03-1108A2-S304	VER R1
Tony Kao	07/13/20					